ASSIGNMENT RECORDATION FORM COVER SHEET Patents Only

To: Commissioner for Patents:	Date: January 30, 2006	
Please record the attached original documents or copy thereof.	Attorney Docket No. 5649-1778	
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):	
[1.] Jae-Eon Park [2.] Ja-Hum Ku [3.] Jun-Hung Kim [4.] Dae-Kwon Kang [5.] Young Way Teh	Samsung Electronics Co., Ltd. 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do REPUBLIC OF KOREA	
Additional name(s) of conveying party(ies) attached? Yes _X_ No		
3. Nature of conveyance: X Assignment Merger Security Agreement Change of Name Other Execution Date: [1.] December 2, 2005 [2.] December 12, 2005 [3.] December 8, 2005 [4.] December 2, 2005 [5.] December 21, 2005	Additional name(s) & address(es) attached? Yes _X No	
4. Application Serial No. 11/246,471; Filed October 7, 2005	_ 	
If this document is being filed together with a new application, to is:	the execution date of the application	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Elizabeth A. Stanek Myers Bigel Sibley & Sajovec P. O. Box 37428	7. Total fee (37 CFR 3.41) \$40.00 Enclosed X Authorized to be charged to deposit account	
Raleigh NC 27627	8. Deposit account number: 50-0220	
DO NOT USE THIS SPACE		
9. Statement and signature To the best of my knowledge and belief, the foregoing information of the original document. Elizabeth A. Stanek, Reg. No. 48,568 Name of Person Signing Signature	<u>January 30, 2006</u> Date	
Total number of pages including cover sheet, attachments and docu	ıment: 7	
I hereby certify that this correspondence is being facsimile facsimile number 571-273-0140 on January 30, 2006. Erm A. Campion	RANSMISSION UNDER 37 CFR § 1.8 transmitted to the U.S. Patent and Trademark Office via	
	PATENT	

700240252

REEL: 017219 FRAME: 0138

ASSIGNMENT

THIS ASSIGNMENT, made by us, Jae-Eon Park, citizen of the Republic of Korea, residing at 102-103 Dongsung Apt., Gomae-ri, Giheung-eup Yongin-si, Gyeonggi-do, Korea; Ja-Hum Ku, citizen of the Republic of Korea, residing at 603-1003 Parkview Apt., Jeongja-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Korea; Jun-Hung Kim, citizen of the Republic of Korea, residing at 814-301 Byeokjeokgol Apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea; Dae-Kwon Kang, citizen of the Republic of Korea, residing at 248-1102 Hwanggolmaeul Ssangyong Apt., Yeongtong-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Korea; and Young Way Teh, citizen of Malaysia, residing at 34 Lorong Mydin, #04-03, Singapore 416827;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in SEMICONDUCTOR DEVICE HAVING A DUAL STRESS LINER, METHOD OF MANUFACTURING THE SEMICONDUCTOR DEVICE AND LIGHT EXPOSURE APPARATUS FOR FORMING THE DUAL STRESS LINER for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. 11/246,471, filed October 7, 2005) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea and Chartered Semiconductor Manufacturing Ltd., a Malaysian corporation having a principal place of business at 60 Woodlands Industrial Park D, Street 2, Singapore 738406, hereinafter referred to as assignees, are desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions

Page 1 of 6

PATENT REEL: 017219 FRAME: 0139

ASSIGNMENT - CONTINUED

and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignce, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignce complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignce, its successors, assigns and other legal representatives.

	IN WITNESS	WHEREOF, I have hereunto set my hand and seal on this 🔼 day
of_	December	2005
		.O. A

Jac-Eon Park

Witnesse	d by:		
	<u></u>		
Date:		_	

ASSIGNMENT - CONTINUED

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this/ day of, 2005
JA-HUM KU
Witnessed by:
Date

3 of 6

PATENT REEL: 017219 FRAME: 0141

ASSIGNMENT - CONTINUED

of		WHEREOF, 11 2005				<u> </u>
		-	Jun Jung Kin	hou	<u>10</u>	
Witnesse	d by:				·	
Date		 -				

ASSIGNMENT - CONTINUED

IN WITNESS WHEREC	OF, I have hereunto set my hand and seal on this day
of, 2005	
	ſ
	Dae-Kwon Kang
	Dae-Kwon Kang
	,
Witnessed by:	
	ı
	_
Date:	

5 of 6

PATENT REEL: 017219 FRAME: 0143

ASSIGNMENT - CONTINUED

of_	IN WITNESS WHEREOF, I have hereunto set my hand and seal on this day, 2005
	Young Way Teh
Witn	essed by:
Date:	

6 of 6

PATENT REEL: 017219 FRAME: 0144

RECORDED: 01/30/2006